

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	28	(deposit near (aluminum or Al)) and sputter and (Al-SI-CU)	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/02 10:30
2	BRS	L2	3	(deposit near (aluminum or Al)) and sputter and (Al-SI-CU) and (si near nodule)	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/02 10:31
3	BRS	L3	584	438/688	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/02 10:34
4	BRS	L4	212	438/663	USPAT; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/02 10:35

449 See Patent Nos. 6,286,290 ; 6,051,490 ; 5,646,449(P/P)
 DP-
 1- 112) (e)
 2- 110) (e) +
 3- 110) (e) + 2 line 37-38
 4- 3- 110) (e) + 2 line 37-38
 5,604,155 ; 5,180,687.

	Type	L #	Hits	Search Text	DBs	Time Stamp
5	BRS	L5	638	438/660	USPAT ; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/0 2 10:35
6	BRS	L6	1972	438/622	USPAT ; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/0 2 10:35
7	BRS	L7	656	438/629	USPAT ; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/0 2 10:35
8	BRS	L8	1236	438/643	USPAT ; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/0 2 10:35

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
1	BRS	L1	28	(deposit near (aluminum or Al)) and sputter and (Al-SI-CU)	USPAT ; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/0 2 10:30			0
2	BRS	L2	3	(deposit near (aluminum or Al)) and sputter and (Al-SI-CU) and (si near nodule)	USPAT ; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/0 2 10:31			0
3	BRS	L3	584	438/688	USPAT ; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/0 2 10:34			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
4	BRS	L4	212	438/663	USPAT ; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/0 2 10:35			0
5	BRS	L5	638	438/660	USPAT ; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/0 2 10:35			0
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8	BRS	L8	1236	438/643	USPAT ; US-PG PUB; EPO; JPO; DERWE NT; IBM TDB	2002/03/0 2 10:35			0